

Semiconductor die products —

Part 3: Recommendations for good practice in handling, packing and storage

ICS 31.080.99

National foreword

This Published Document is the UK implementation of CLC/TR 62258-3:2007. It is identical to IEC/TR 62258-3:2005. It supersedes PD IEC/TR 62258-3:2005 and PD ES 59008-4-2:2001, which are withdrawn.

The UK participation in its preparation was entrusted to Technical Committee EPL/47, Semiconductors.

A list of organizations represented on this committee can be obtained on request to its secretary.

This publication does not purport to include all the necessary provisions of a contract. Users are responsible for its correct application.

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